# VS-SD2000C..L Series

**Vishay Semiconductors** 

## **Standard Recovery Diodes,** (Hockey PUK Version), 2100 A



B-PUK (DO-200AB)

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub> 2100 A					
Package	B-PUK (DO-200AB)				
Circuit configuration Single					

### **FEATURES**

- Wide current range
- High voltage ratings up to 1000 V
- · High surge current capabilities
- Diffused junction
- Hockey PUK version
- Case style B-PUK (DO-200AB)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **TYPICAL APPLICATIONS**

- Converters
- Power supplies
- High power drives
- · Auxiliary system supplies for traction applications

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		2100	А			
IF(AV)	T <sub>hs</sub>	55	°C			
1		3900	A			
IF(RMS)	T <sub>hs</sub>	25	°C			
I <sub>FSM</sub>	50 Hz	23 900	A			
	60 Hz	25 000				
l <sup>2</sup> t	50 Hz	2857	kA <sup>2</sup> s			
1-1	60 Hz	2608	KA <sup>2</sup> S			
V <sub>RRM</sub>	Range	400 to 1000	V			
TJ		-40 to +180	°C			

#### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> MAXIMUM AT T <sub>J</sub> = 180 °C mA				
	04	400	500					
VS-SD2000CL	08	800	900	60				
	10	1000	1100					

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FORWARD CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average forward current	1	180° conduction, half sine wave			2100 (1040)	А
at heatsink temperature	I <sub>F(AV)</sub>	Double side (s	single side) coole	ed	55 (85)	°C
Maximum RMS forward current	I <sub>F(RMS)</sub>	25 °C heatsin	k temperature de	ouble side cooled	3900	
		t = 10 ms	No voltage		23 900	A kA²s
Maximum peak, one-cycle forward,		t = 8.3 ms	reapplied		25 000	
non-repetitive surge current	I <sub>FSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		20 100	
		t = 8.3 ms	reapplied	Sinusoidal half wave, initial T <sub>J</sub> = T <sub>J</sub> maximum	21 000	
Maximum I <sup>2</sup> t for fusing	ximum l <sup>2</sup> t for fusing $l^{2}t$ $l^{2}t$ $t = 10 \text{ ms}$ No voltage reapplied $t = 8.3 \text{ ms}$ reapplied $t = 10 \text{ ms}$ 100 % V <sub>RBM</sub> reapplied reapplied $t = 8.3 \text{ ms}$ reapplied	t = 10 ms	Ŭ		2857	
		t = 8.3 ms			2608	
		t = 10 ms	100 % V <sub>BBM</sub>		2020	
				1844	ļ	
Maximum I <sup>2</sup> √t for fusing	l²√t	t = 0.1 to 10 ms, no voltage reapplied			28 570	kA²√s
Low level value of threshold voltage	V <sub>F(TO)1</sub>	(16.7 % x π x	$I_{F(AV)} < I < \pi \times I_{F(AV)}$	0.74	V	
High level value of threshold voltage	V <sub>F(TO)2</sub>	$(I > \pi \times I_{F(AV)}), T_J = T_J maximum$			0.86	v
Low level value of forward slope resistance	r <sub>f1</sub>	(16.7 % x $\pi$ x I <sub>F(AV)</sub> < I < $\pi$ x I <sub>F(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> maximum			0.13	mW
High level value of forward slope resistance	r <sub>f2</sub>	$(I > \pi \times I_{F(AV)}),$	T <sub>J</sub> = T <sub>J</sub> maximur	n	0.12	11174
Maximum forward voltage drop	V <sub>FM</sub>	I <sub>pk</sub> = 6000 A, T	J = TJ maximum	, t <sub>p</sub> = 10 ms sinusoidal wave	1.55	V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction operating temperature range	TJ		-40 to +180	°C	
Maximum storage temperature range	T <sub>Stg</sub>		-55 to +200		
Maximum thermal resistance,	D	DC operation single side cooled	0.073	K/W	
junction to heatsink	R <sub>thJ-hs</sub>	DC operation double side cooled	0.031	r∨ W	
Mounting force, ± 10 %			14 700 (1500)	N (kg)	
Approximate weight			255	g	
Case style		See dimensions - link at the end of datasheet B-PUK (DO-200AB		-200AB)	

CONDUCTION ANGLE	SINUSOIDAL C	ONDUCTION	TEST CONDITIONS	UNITS				
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS		
180°	0.009	0.009	0.006	0.006				
120°	0.011	0.011	0.011	0.011		K/W		
90°	0.014	0.014	0.015	0.015	$T_J = T_J maximum$			
60°	0.020	0.020	0.021	0.021				
30°	0.036	0.036	0.036	0.036				

Note

• The table above shows the increment of thermal resistance R<sub>thJ-hs</sub> when devices operate at different conduction angles than DC



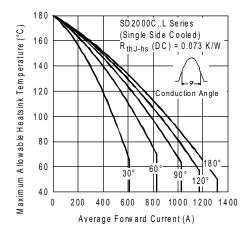


Fig. 1 - Current Ratings Characteristics

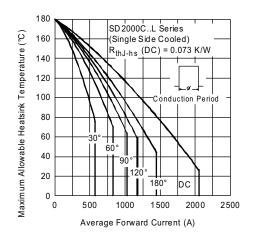


Fig. 2 - Current Ratings Characteristics

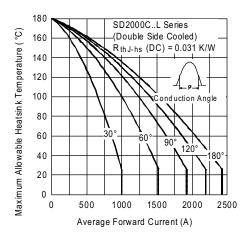


Fig. 3 - Current Ratings Characteristics

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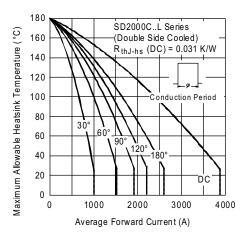


Fig. 4 - Current Ratings Characteristics

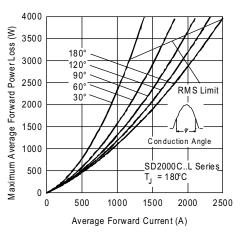


Fig. 5 - Forward Power Loss Characteristics

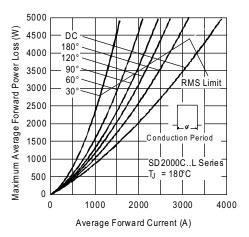


Fig. 6 - Forward Power Loss Characteristics

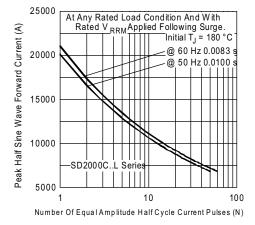
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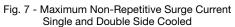
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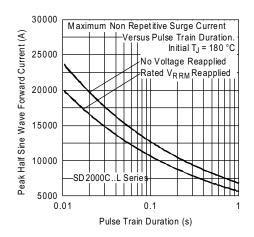


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

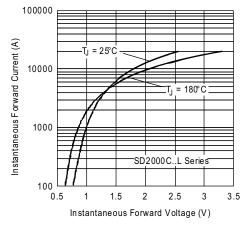


Fig. 9 - Forward Voltage Drop Characteristics

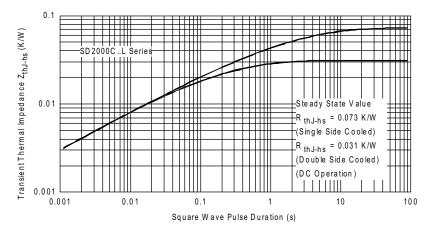


Fig. 10 - Thermal Impedance ZthJ-hs Characteristics

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Device code	VS-	SD	200	0	с	10	L
	1	2	3	4	5	6	7
	1 -		-	niconduc	ctors pro	oduct	
	2 -	Dio		art numt	ber		
	4 · 5 ·		standar ceramio	d recove c PUK	ery		
	6 - 7 -		•	le x 100 se B-PU			•

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95246			

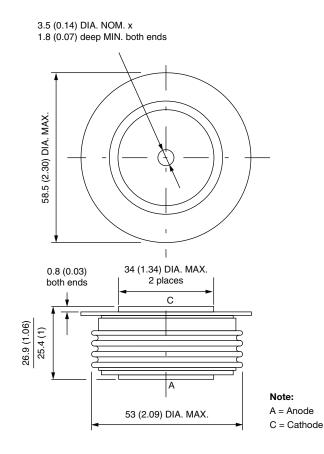






B-PUK (DO-200AB)

#### **DIMENSIONS** in millimeters (inches)



Quote between upper and lower pole pieces has to be considered after application of mounting force (see Thermal and Mechanical Specifications)



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